

06-24-1999



101073925

## RECORDATION FORM COVER SHEET

Docket: 0819-250

To the Honorable Assistant Commissioner for Patent. Please record the attached original documents or copy thereof.

1. Name of conveying parties: Kyoko EGASHIRA, Koji ERIGUCHI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party:

Name: Matsushita Electronics Corporation

Street Address: 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan

City \_\_\_\_\_ State \_\_\_\_\_ ZIP \_\_\_\_\_

Additional name(s) & addresses(es) attached? ☐ Yes ☒ No

3. Name of Conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other \_\_\_\_\_

Execution Date: June 4, 1999

4. Application number(s) or patent number(s):

09/327,467

If this document is being filed together with a new application, the execution date of the application is: June 4, 1999

Title: METHOD FOR EXAMINING SEMICONDUCTOR SUBSTRATE, AND METHOD FOR CONTROLLING FABRICATION PROCESS OF SEMICONDUCTOR DEVICES

A: Patent Application No.(s)

B: Patent No.(s)

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: SIXBEY, FRIEDMAN, LEEDOM & FERGUSON, P.C.

Street Address: 8180 Greensboro Drive, Suite 800

City: McLean State: Virginia ZIP 22102

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): .....\$40.00

☒ Enclosed

☐ Authorized to be changed to deposit account

8. Deposit Account Number: \_\_\_\_\_

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

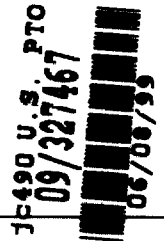
Eric J. Robinson

Name of Person Signing

[Signature]  
Signature

6-8-99  
Date

Total number of pages including cover sheet, attachments, and document: 3



09/327467  
40.00  
00000066  
06/21/1999  
02 10:53A

PATENT  
REEL: 010037 FRAME: 0008

Attorney Docket No. \_\_\_\_\_

ASSIGNMENT

WHEREAS, Kyoko EGASHIRA, Koji ERIGUCHI

\_\_\_\_\_ (hereinafter designated as the undersigned) has (have) invented certain new  
and useful improvements in METHOD FOR EXAMINING SEMICONDUCTOR  
SUBSTRATE, AND METHOD FOR CONTROLLING FABRICATION PROCESS OF  
SEMICONDUCTOR DEVICES

for which an application for Letters Patent of the United States of America has been executed by  
the undersigned on June 4, 1999, and;

WHEREAS, Matsushita Electronics Corporation of  
1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee)  
is desirous of acquiring the entire right, title and interest in and to said invention and in and to  
any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the  
undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and  
valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these  
presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said  
invention in the United States of America and its territories and for all foreign countries,  
dependencies and possessions and the entire right, title and interest in and to any and all Letters  
Patent(s) which may be granted therefor in the United States of America and its territories,  
dependencies and possessions, and in and to any and all divisions, reissues, continuations and  
extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this  
application and any continuing, divisional or reissue applications thereof and also to execute  
separate assignments in connection with such applications as the Assignee may deem necessary  
or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any  
interference which may be declared concerning this application or any continuation, division or  
reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the  
Assignee in every way possible in obtaining and producing evidence and proceeding with such  
interference.

The undersigned agree(s) to execute all papers and documents and to perform any act  
which may be necessary in connection with claims under or provisions of the International  
Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Sixbey, Friedman, Leedom & Ferguson, P.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

*In witness thereof*, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date June 4, 1999, Name of Inventor *Kyoko Egashira* (SEAL)  
**Kyoko EGASHIRA**

Date June 4, 1999, Name of Inventor *Koji Eriguchi* (SEAL)  
**Koji ERIGUCHI**

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

(This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.)

Witness Kazuya KIKUCHI  
(name)

*Kazuya Kikuchi*  
(signature)

Witness Kenji KAWAKITA  
(name)

*Kenji Kawakita*  
(signature)